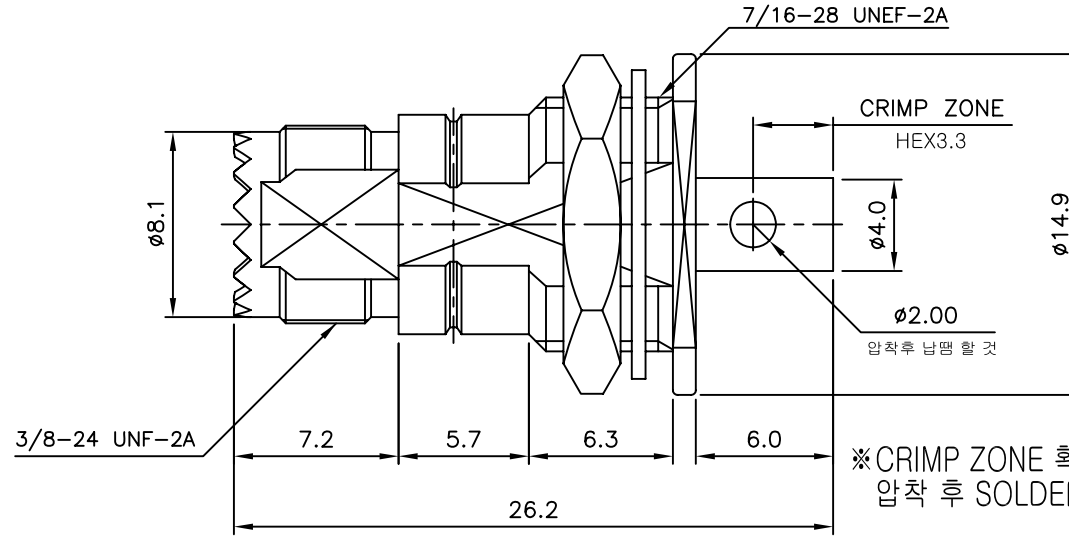
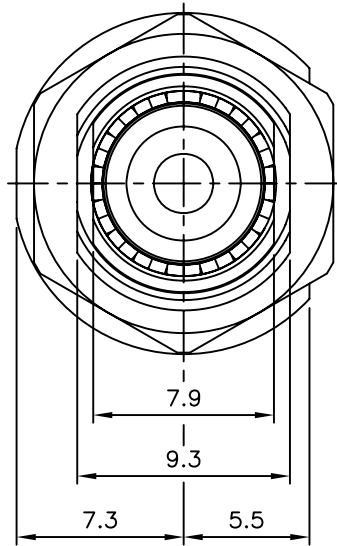
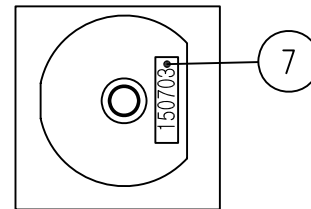


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.M.LEE	I.C.KIM	2015.06.22.



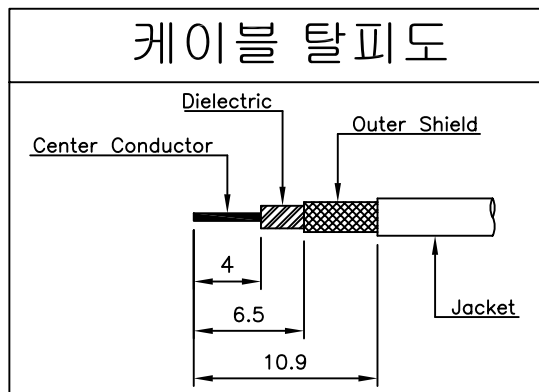
※CRIMP ZONE 확인 후 작업 할 것
압착 후 SOLDER작업 할 것

*라벨 부착 위치



7	LABEL	1	은무 데드롱		DLA00644-8/1
6	WASHER	1	BsS	Nickel Plate	DWA00023-5/1
5	NUT	1	MBsBD C3604BD-F	Nickel Plate	DNT00047-5/1
4	INSULATOR	1	TEFLON		DIN00607-N/1
3	CONTACT	1	BeCu C17300	Gold Plate	DCT00608-N/1
2	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD03960-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD03961-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

케이블 탈피도



TOLERANCE	Decimal	DATE 2015. 06. 05.	
	Angle	APPROVED BY I.C.KIM	
MATERIAL		CHECKED BY	
		DRAWN BY S.M.LEE	
FINISH		SCALE 3/1	
		UNIT mm	



KJ COMTECH CO.,LTD.

RF & MICROWAVE
TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE UHF(MINI)50 JB (F/N)

DWG NO. CN01110-7/2

REVISION I R SHEET 1 of 1

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